

## 1. General description

AC Thyristor Triac power switch in a SOT428 (DPAK) surface mountable plastic package with self-protective clamping capabilities against low and high energy transients.

## 2. Features and benefits

- Clamping structure ensuring safe high over-voltage withstand capability
- Direct interfacing with low power drivers and microcontrollers
- Full cycle AC conduction
- Over-voltage withstand capability to IEC 61000-4-5
- Pin compatible with standard triacs
- Planar passivated for voltage ruggedness and reliability
- Protective self turn-on capability for high energy transients
- Safe clamping capability for low energy over-voltage transients
- Sensitive gate for easy logic level triggering
- Surface mountable package
- Triggering in three quadrants only
- Very high immunity to false turn-on by dV/dt

## 3. Applications

- AC fan, pump and compressor controls
- Highly inductive, resistive and safety loads
- Large and small appliances (White Goods)
- Reversing induction motor controls

## 4. Quick reference data

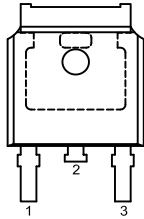
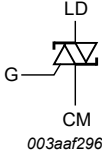
Table 1. Quick reference data

| Symbol       | Parameter                            | Conditions                                                                                                             | Min | Typ | Max  | Unit |
|--------------|--------------------------------------|------------------------------------------------------------------------------------------------------------------------|-----|-----|------|------|
| $V_{DRM}$    | repetitive peak off-state voltage    |                                                                                                                        | -   | -   | 800  | V    |
| $I_{T(RMS)}$ | RMS on-state current                 | full sine wave; $T_{mb} \leq 115\text{ °C}$ ; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a> | -   | -   | 2    | A    |
| $I_{TSM}$    | non-repetitive peak on-state current | full sine wave; $T_{j(init)} = 25\text{ °C}$ ; $t_p = 16.7\text{ ms}$                                                  | -   | -   | 15.4 | A    |
|              |                                      | full sine wave; $T_{j(init)} = 25\text{ °C}$ ; $t_p = 20\text{ ms}$ ; <a href="#">Fig. 4</a> ; <a href="#">Fig. 5</a>  | -   | -   | 14   | A    |
| $T_j$        | junction temperature                 |                                                                                                                        | -   | -   | 125  | °C   |
| $V_{PP}$     | peak pulse voltage                   | $T_j = 25\text{ °C}$ ; non-repetitive, off-state; <a href="#">Fig. 6</a>                                               | -   | -   | 2    | kV   |

| Symbol                         | Parameter                             | Conditions                                                                                                                                                                                            | Min | Typ | Max | Unit             |
|--------------------------------|---------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------------------|
| <b>Static characteristics</b>  |                                       |                                                                                                                                                                                                       |     |     |     |                  |
| $I_{GT}$                       | gate trigger current                  | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD+ G+; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>                                                                                       | -   | -   | 10  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD+ G-; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>                                                                                       | -   | -   | 10  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD- G-; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>                                                                                       | -   | -   | 10  | mA               |
| $I_H$                          | holding current                       | $V_D = 12\text{ V}$ ; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 10</a>                                                                                                                      | -   | -   | 25  | mA               |
| $V_T$                          | on-state voltage                      | $I_T = 3\text{ A}$ ; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 11</a>                                                                                                                       | -   | -   | 2   | V                |
| $V_{CL}$                       | clamping voltage                      | $I_{CL} = 0.1\text{ mA}$ ; $t_p = 1\text{ ms}$ ; $T_j = 25\text{ }^\circ\text{C}$                                                                                                                     | 850 | -   | -   | V                |
| <b>Dynamic characteristics</b> |                                       |                                                                                                                                                                                                       |     |     |     |                  |
| $dV_D/dt$                      | rate of rise of off-state voltage     | $V_{DM} = 536\text{ V}$ ; $T_j = 125\text{ }^\circ\text{C}$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform; gate open circuit; <a href="#">Fig. 13</a>                                      | 500 | -   | -   | V/ $\mu\text{s}$ |
| $dI_{com}/dt$                  | rate of change of commutating current | $V_D = 400\text{ V}$ ; $T_j = 125\text{ }^\circ\text{C}$ ; $I_{T(RMS)} = 2\text{ A}$ ; $dV_{com}/dt = 10\text{ V}/\mu\text{s}$ ; gate open circuit; <a href="#">Fig. 14</a> ; <a href="#">Fig. 15</a> | 3   | -   | -   | A/ms             |

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description         | Simplified outline                                                                                              | Graphic symbol                                                                                         |
|-----|--------|---------------------|-----------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|
| 1   | CM     | common              |  <p><b>DPAK (SOT428)</b></p> |  <p>003aaf296</p> |
| 2   | LD     | load                |                                                                                                                 |                                                                                                        |
| 3   | G      | gate                |                                                                                                                 |                                                                                                        |
| mb  | LD     | mounting base; load |                                                                                                                 |                                                                                                        |

## 6. Ordering information

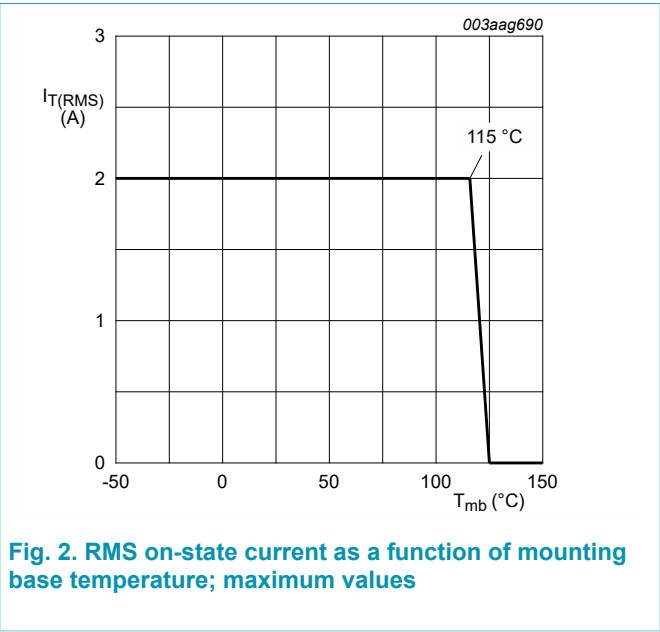
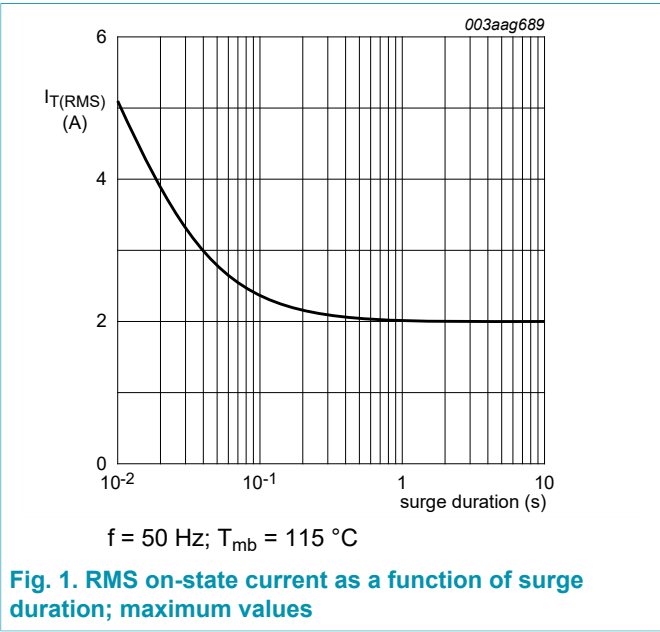
Table 3. Ordering information

| Type number | Package |                                                                                 |         |
|-------------|---------|---------------------------------------------------------------------------------|---------|
|             | Name    | Description                                                                     | Version |
| ACTT2S-800E | DPAK    | plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped) | SOT428  |

7. Limiting values

Table 4. Limiting values  
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol              | Parameter                            | Conditions                                                                           | Min | Max  | Unit             |
|---------------------|--------------------------------------|--------------------------------------------------------------------------------------|-----|------|------------------|
| V <sub>DRM</sub>    | repetitive peak off-state voltage    |                                                                                      | -   | 800  | V                |
| I <sub>T(RMS)</sub> | RMS on-state current                 | full sine wave; T <sub>mb</sub> ≤ 115 °C; Fig. 1; Fig. 2; Fig. 3                     | -   | 2    | A                |
| I <sub>TSM</sub>    | non-repetitive peak on-state current | full sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 16.7 ms               | -   | 15.4 | A                |
|                     |                                      | full sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 20 ms; Fig. 4; Fig. 5 | -   | 14   | A                |
| I <sup>2</sup> t    | I <sup>2</sup> t for fusing          | t <sub>p</sub> = 10 ms; sine-wave pulse                                              | -   | 0.98 | A <sup>2</sup> s |
| dI <sub>T</sub> /dt | rate of rise of on-state current     | I <sub>G</sub> = 20 mA                                                               | -   | 100  | A/μs             |
| I <sub>GM</sub>     | peak gate current                    | t = 20 μs                                                                            | -   | 2    | A                |
| P <sub>GM</sub>     | peak gate power                      |                                                                                      | -   | 5    | W                |
| P <sub>G(AV)</sub>  | average gate power                   | over any 20 ms period                                                                | -   | 0.5  | W                |
| T <sub>j</sub>      | junction temperature                 |                                                                                      | -   | 125  | °C               |
| V <sub>PP</sub>     | peak pulse voltage                   | T <sub>j</sub> = 25 °C; non-repetitive, off-state; Fig. 6                            | -   | 2    | kV               |



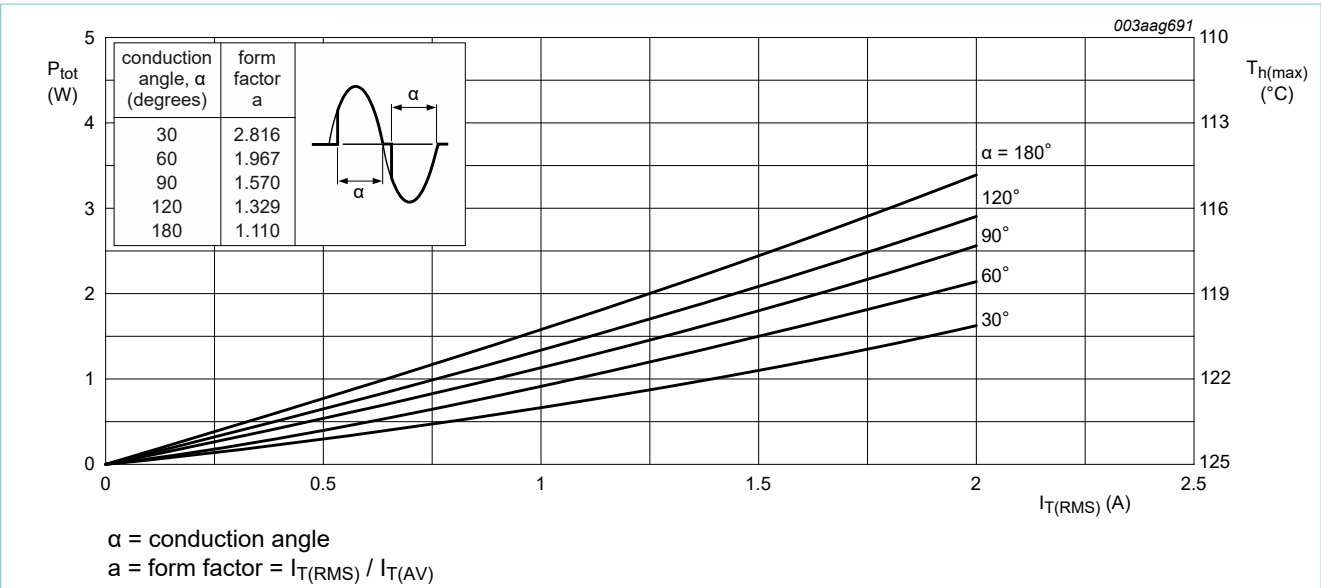


Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values

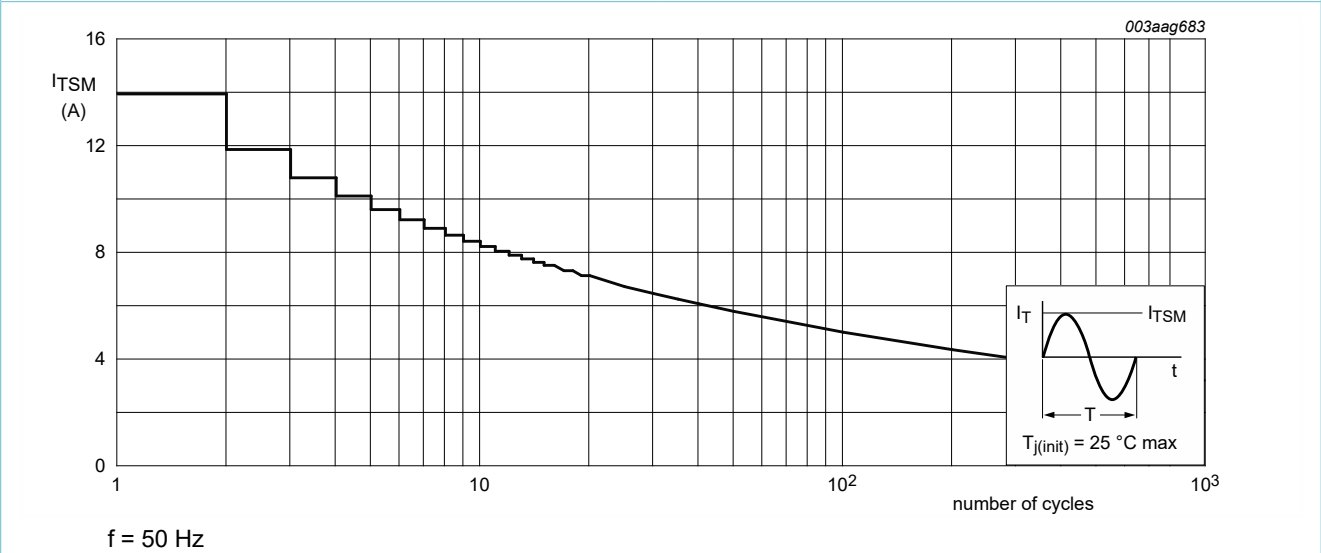


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

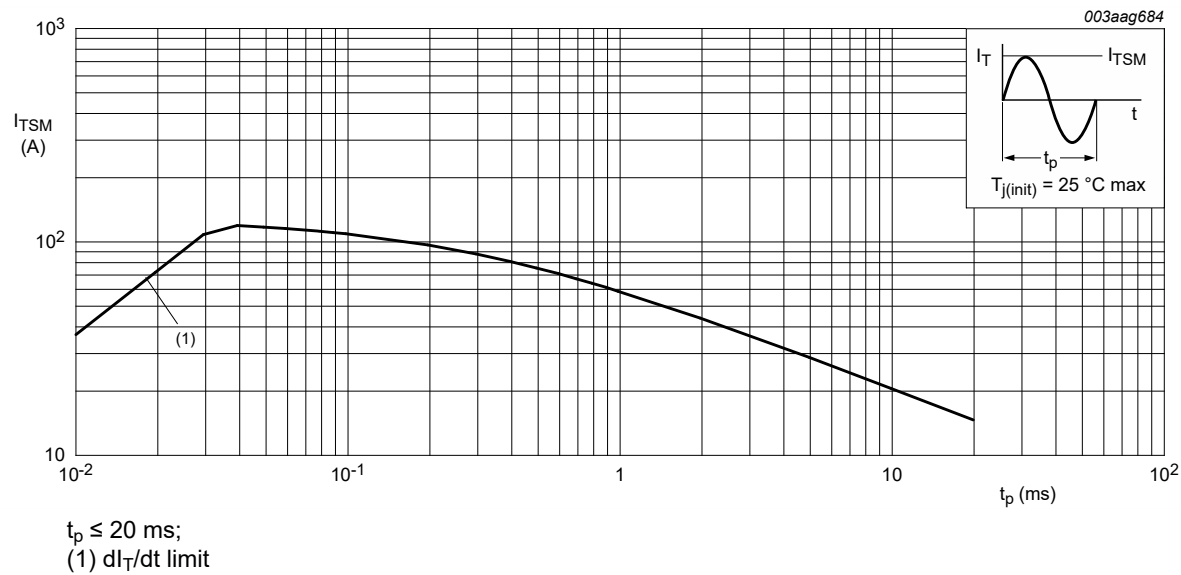


Fig. 5. Non-repetitive peak on-state current as a function of pulse width; maximum values

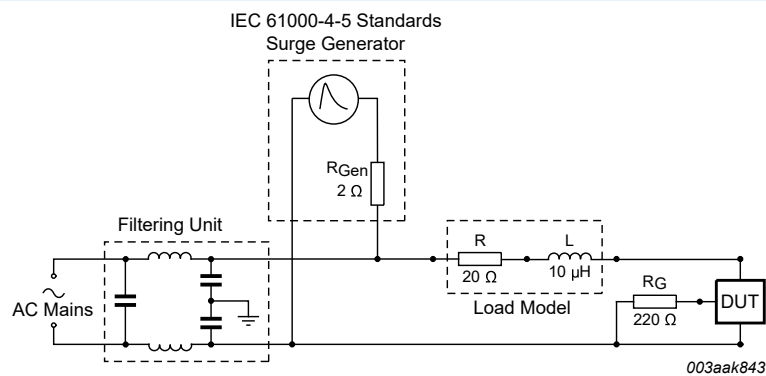
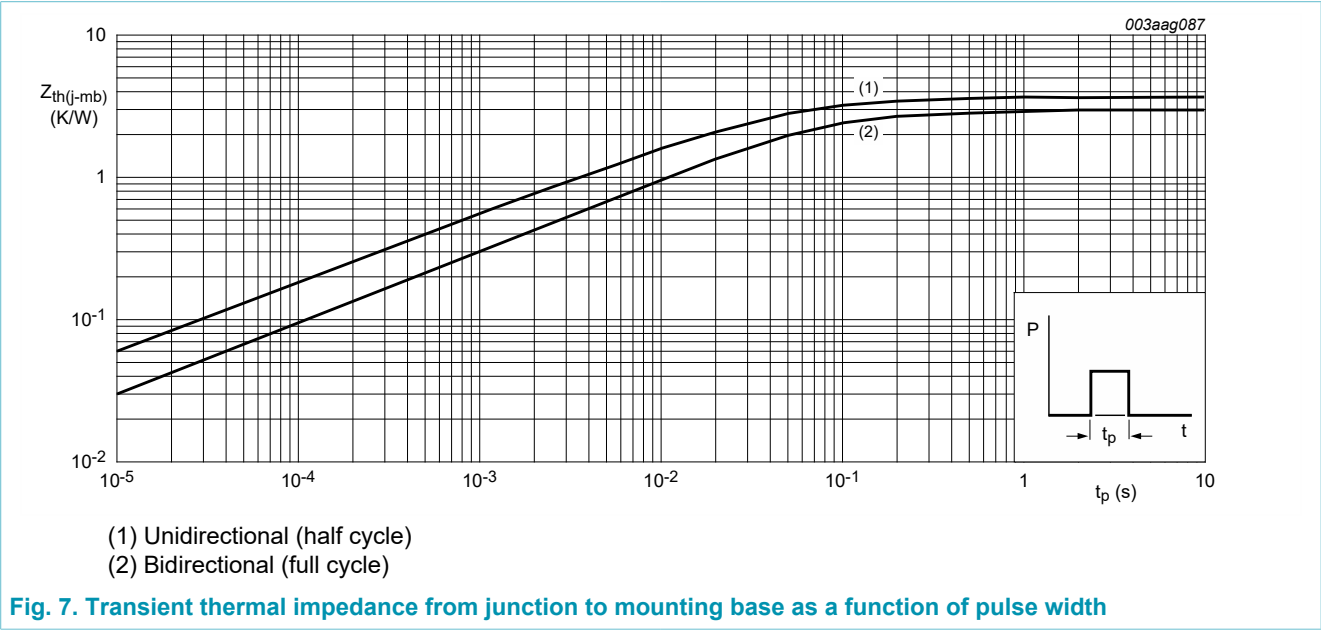


Fig. 6. Test circuit for inductive and resistive loads with conditions equivalent to IEC 61000-4-5

8. Thermal characteristics

Table 5. Thermal characteristics

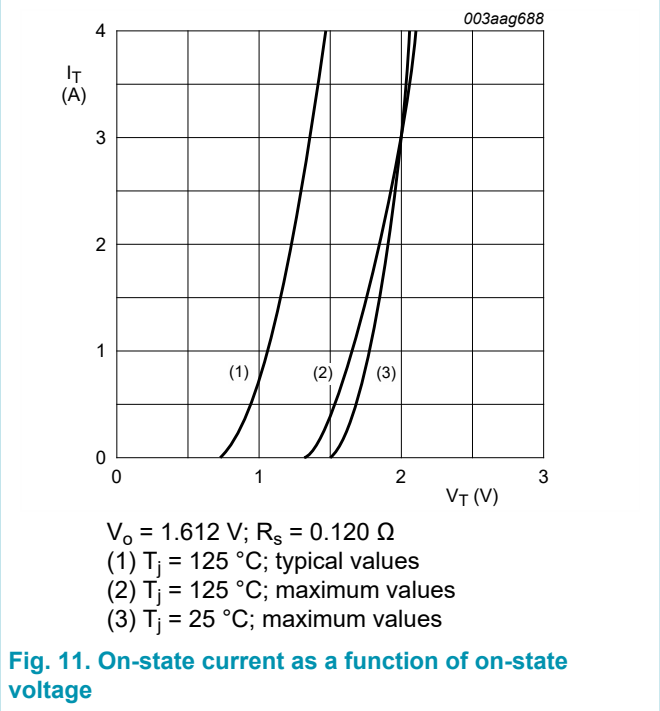
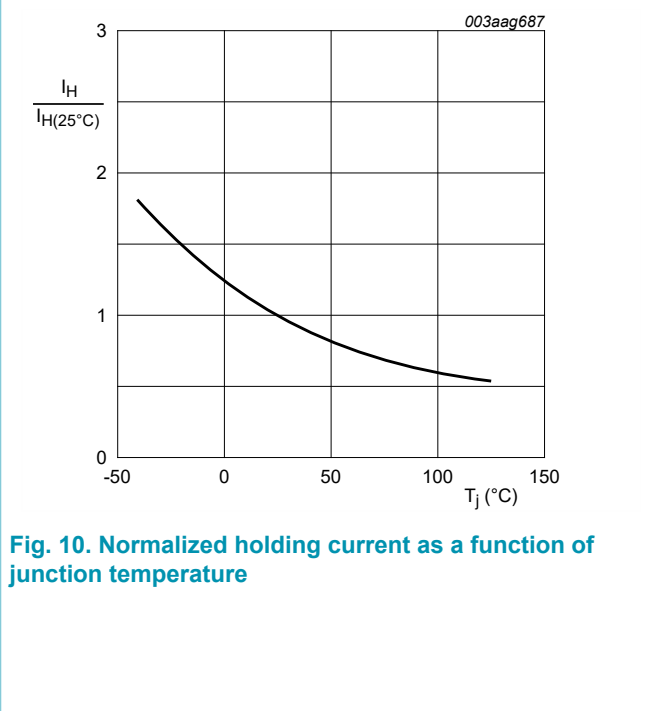
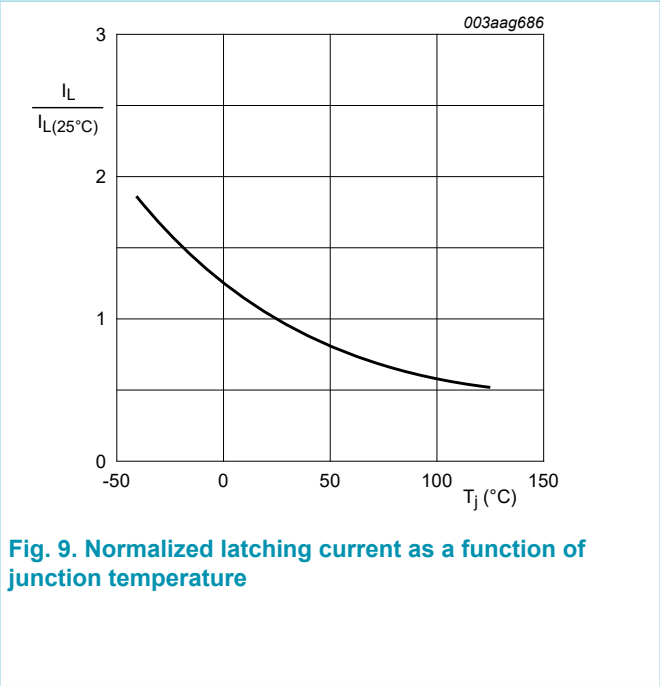
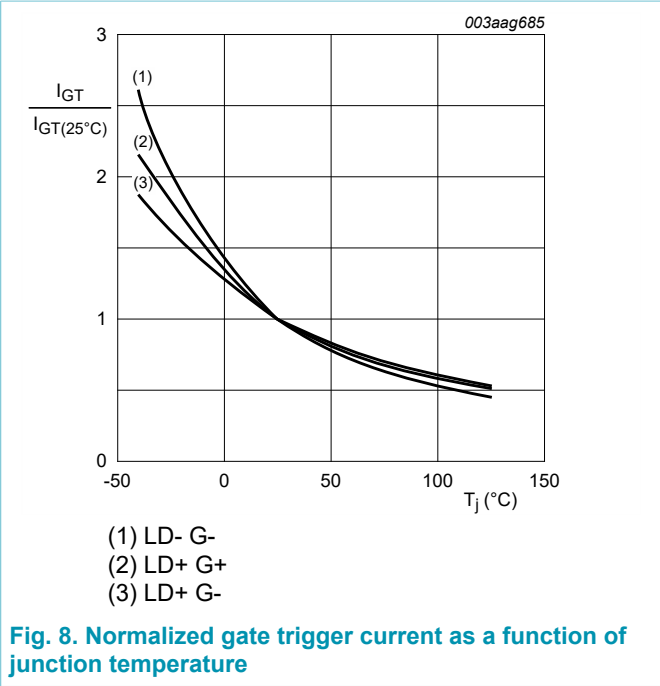
| Symbol         | Parameter                                            | Conditions                          | Min | Typ | Max | Unit |
|----------------|------------------------------------------------------|-------------------------------------|-----|-----|-----|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base    | full cycle; Fig. 7                  | -   | -   | 3   | K/W  |
| $R_{th(j-a)}$  | thermal resistance from junction to ambient free air | printed circuit board (FR4) mounted | -   | 75  | -   | K/W  |

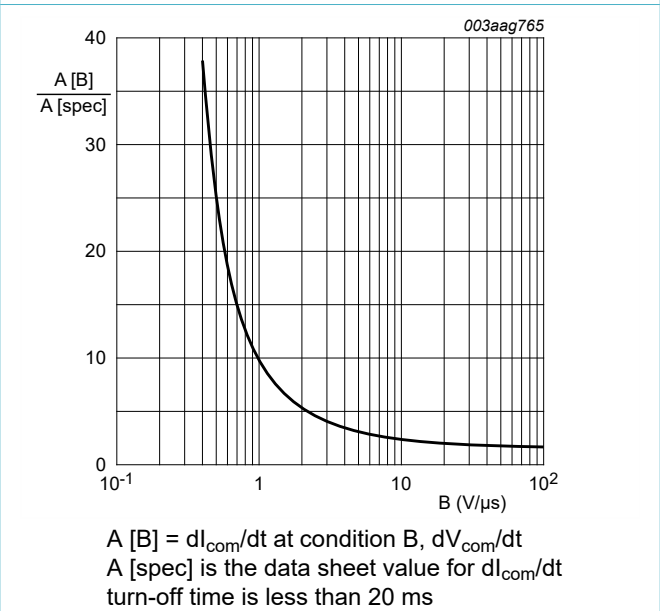
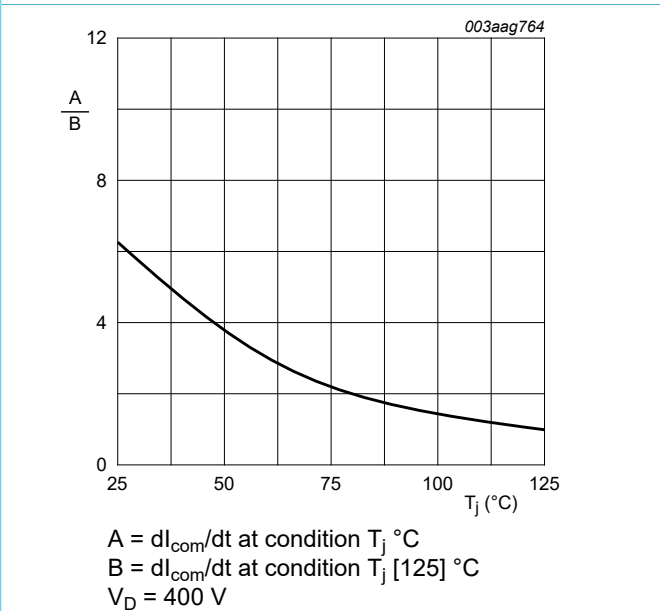
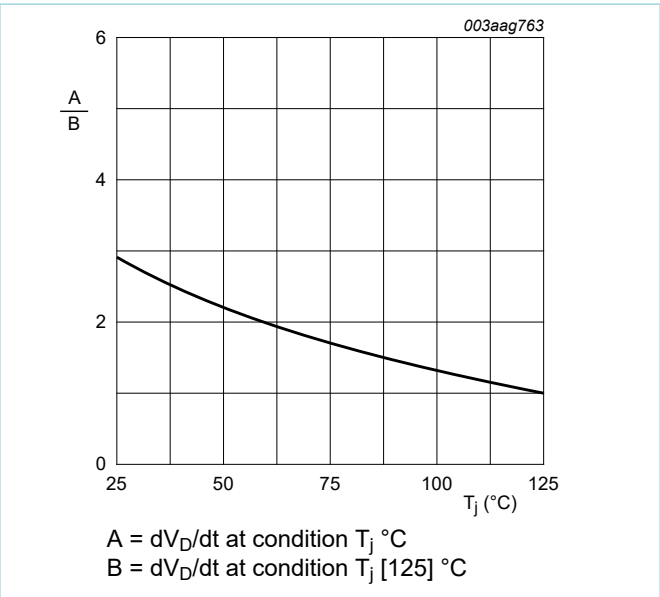
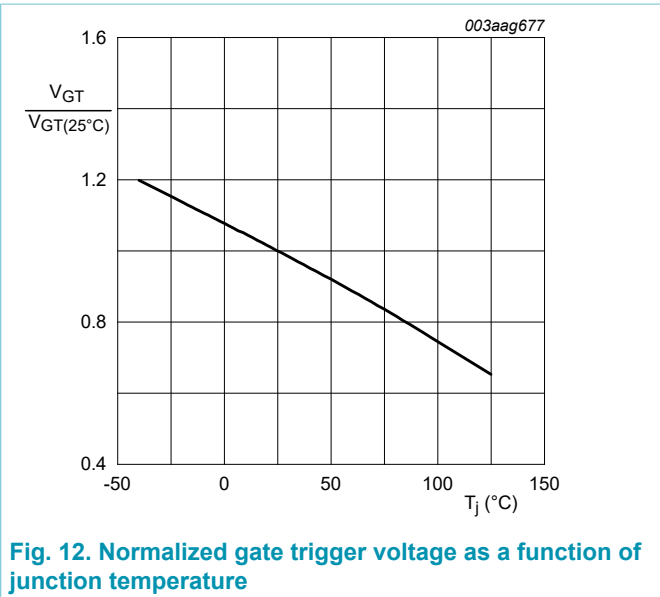


## 9. Characteristics

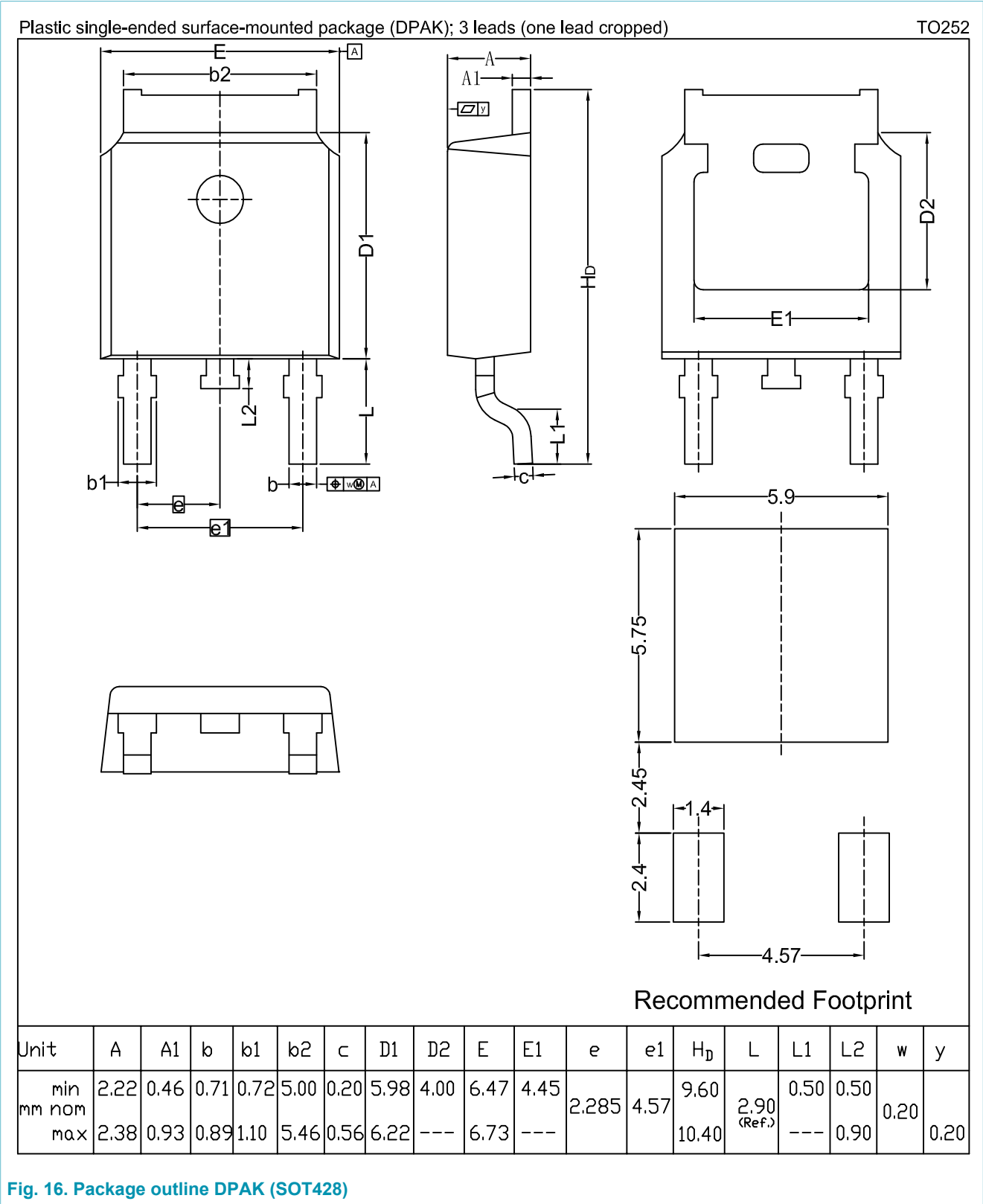
Table 6. Characteristics

| Symbol                         | Parameter                             | Conditions                                                                                                                                                                                |  | Min | Typ  | Max | Unit             |
|--------------------------------|---------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|-----|------|-----|------------------|
| <b>Static characteristics</b>  |                                       |                                                                                                                                                                                           |  |     |      |     |                  |
| $I_{GT}$                       | gate trigger current                  | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD+ G+;<br>$T_j = 25\text{ °C}$ ; <a href="#">Fig. 8</a>                                                                                    |  | -   | -    | 10  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD+ G-;<br>$T_j = 25\text{ °C}$ ; <a href="#">Fig. 8</a>                                                                                    |  | -   | -    | 10  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD- G-;<br>$T_j = 25\text{ °C}$ ; <a href="#">Fig. 8</a>                                                                                    |  | -   | -    | 10  | mA               |
| $I_L$                          | latching current                      | $V_D = 12\text{ V}$ ; $I_G = 100\text{ mA}$ ; LD+ G+;<br>$T_j = 25\text{ °C}$ ; <a href="#">Fig. 9</a>                                                                                    |  | -   | -    | 25  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_G = 100\text{ mA}$ ; LD+ G-;<br>$T_j = 25\text{ °C}$ ; <a href="#">Fig. 9</a>                                                                                    |  | -   | -    | 30  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_G = 100\text{ mA}$ ; LD- G-;<br>$T_j = 25\text{ °C}$ ; <a href="#">Fig. 9</a>                                                                                    |  | -   | -    | 25  | mA               |
| $I_H$                          | holding current                       | $V_D = 12\text{ V}$ ; $T_j = 25\text{ °C}$ ; <a href="#">Fig. 10</a>                                                                                                                      |  | -   | -    | 25  | mA               |
| $V_T$                          | on-state voltage                      | $I_T = 3\text{ A}$ ; $T_j = 25\text{ °C}$ ; <a href="#">Fig. 11</a>                                                                                                                       |  | -   | -    | 2   | V                |
| $V_{GT}$                       | gate trigger voltage                  | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; $T_j = 25\text{ °C}$ ;<br><a href="#">Fig. 12</a>                                                                                           |  | -   | 0.8  | 1   | V                |
|                                |                                       | $V_D = 400\text{ V}$ ; $I_T = 100\text{ mA}$ ; $T_j = 125\text{ °C}$ ;<br><a href="#">Fig. 12</a>                                                                                         |  | 0.2 | 0.45 | -   | V                |
| $I_D$                          | off-state current                     | $V_D = 800\text{ V}$ ; $T_j = 25\text{ °C}$                                                                                                                                               |  | -   | -    | 10  | $\mu\text{A}$    |
|                                |                                       | $V_D = 800\text{ V}$ ; $T_j = 125\text{ °C}$                                                                                                                                              |  | -   | -    | 0.5 | mA               |
| $V_{CL}$                       | clamping voltage                      | $I_{CL} = 0.1\text{ mA}$ ; $t_p = 1\text{ ms}$ ; $T_j = 25\text{ °C}$                                                                                                                     |  | 850 | -    | -   | V                |
| <b>Dynamic characteristics</b> |                                       |                                                                                                                                                                                           |  |     |      |     |                  |
| $dV_D/dt$                      | rate of rise of off-state voltage     | $V_{DM} = 536\text{ V}$ ; $T_j = 125\text{ °C}$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform; gate open circuit; <a href="#">Fig. 13</a>                                      |  | 500 | -    | -   | V/ $\mu\text{s}$ |
| $dI_{com}/dt$                  | rate of change of commutating current | $V_D = 400\text{ V}$ ; $T_j = 125\text{ °C}$ ; $I_{T(RMS)} = 2\text{ A}$ ; $dV_{com}/dt = 10\text{ V}/\mu\text{s}$ ; gate open circuit; <a href="#">Fig. 14</a> ; <a href="#">Fig. 15</a> |  | 3   | -    | -   | A/ms             |





10. Package outline



## 11. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition                                                                            |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
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